1 Characteristics

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Symbol	Parameter		Value	Unit	
V _{RRM}	Repetitive peak reverse voltage			40	V
		SMB	T _L = 130 °C		A
I _{F(AV)}	Average forward current, δ = 0.5, square wave	SMB Flat	T _L = 140 °C	2	
		SMA Flat, SMA Flat Notch	T _L = 130 °C		
I _{FSM}	Surge non repetitive forward current	75	Α		
P _{ARM}	Repetitive peak avalanche power	158	W		
T _{stg}	Storage temperature range	-65 to +150	°C		
Tj	Maximum operating junction temperature ⁽¹⁾	+150	°C		

Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified)

1. $(dP_{tot}/dT_j) < (1/R_{th(j-a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 2. Thermal resistance parameter

Symbol	Parameter	Max. value	Unit		
		SMB	20		
Dama		SMB Flat	10	°C/W	
R _{th(j-l)}	Junction to lead	SMA Flat	20	- C/W	
		SMA Flat Notch	20		

For more information, please refer to the following application note :

AN5088 : Rectifiers thermal management, handling and mounting recommendations

Table 3. Static electrical characteristics

Symbol	Parameter	Test cor	Test conditions		Тур.	Max.	Unit
		T _j = 25 °C		-		220	μA
I _R ⁽¹⁾	Reverse leakage current	T _j = 100 °C	V _R = 40 V	-		20	mA
		T _j = 125 °C		-	38	80	mA
		T _j = 25 °C	I _F = 1 A	-		0.39	mA
		T _j = 125 °C	IF - I A	-	0.25	0.28	
V _F ⁽¹⁾		T _j = 25 °C	$I_F = 2 A$ $I_F = 4 A$	-		0.43	
VF	Forward voltage drop	T _j = 125 °C		-	0.31	0.34	V
		T _j = 25 °C		-		0.50	
		T _j = 125 °C	IF = 4 M	-	0.39	0.45	

1. Pulse test: $t_p = 380 \ \mu s, \ \delta < 2\%$

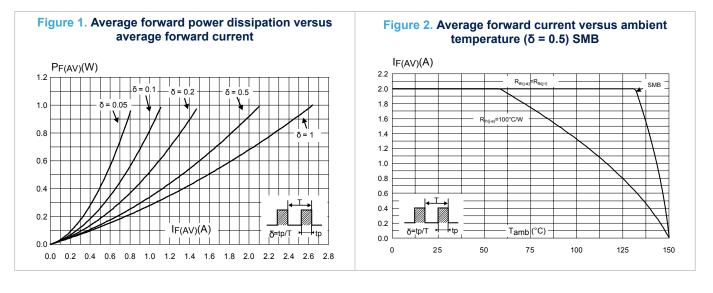
To evaluate the conduction losses, use the following equation:

 $P = 0.22 \text{ x } I_{F(AV)} + 0.06 \text{ x } I_{F}^{2}(RMS)$

For more information, please refer to the following application notes related to the power losses :

- AN604: Calculation of conduction losses in a power rectifier
- AN4021: Calculation of reverse losses on a power diode

1.1 Characteristics (curves)



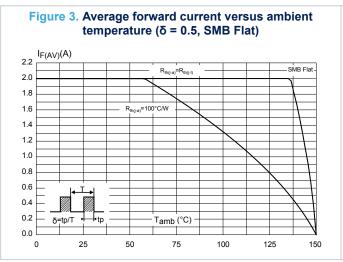
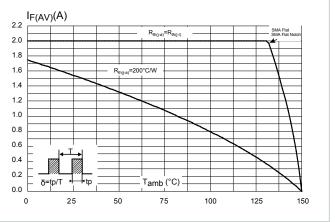


Figure 4. Average forward current versus ambient temperature (δ = 0.5, SMA Flat, SMA Flat Notch)





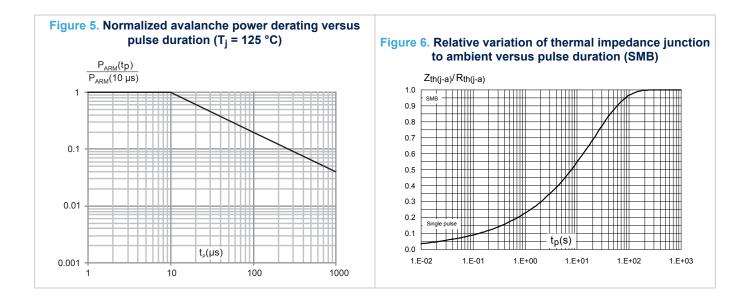
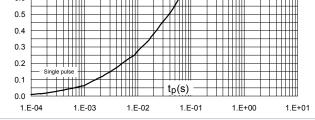


Figure 7. Relative variation of thermal impedance junction Figure 8. Relative variation of thermal impedance junction to lead versus pulse duration (SMB flat) to ambient versus pulse duration (SMA Flat) Zth(j-I) / Rth(j-I) Zth(j-a)/Rth(j-a) 1.0 1.0 111111 0.9 SMA Flat / SMA Flat Notch 0.9 1 1 1 1 1 1 0.8 0.8 ΠI 0.7 0.7 0.6 0.6

0.5

0.4



ТП ++++0.3 0.2 0.1 tp(s) 0.0 1.E+00 1.E+01 1.E+02 1.E-02 1.E-01 1.E+03

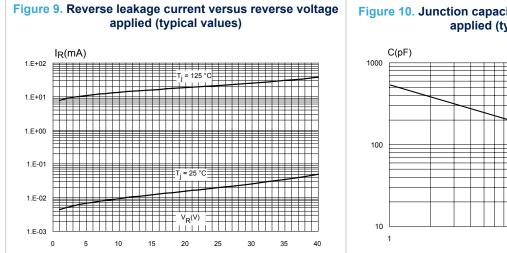
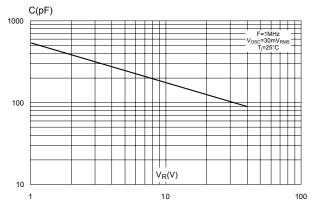
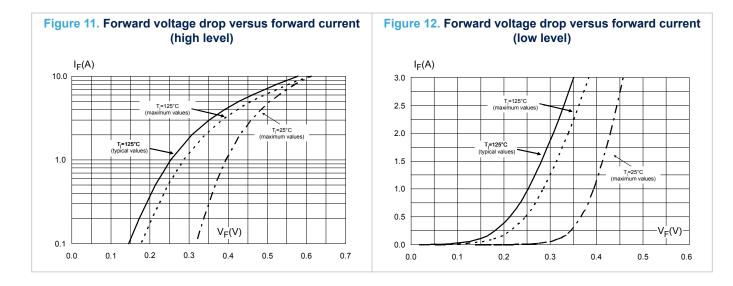


Figure 10. Junction capacitance versus reverse voltage applied (typical values)







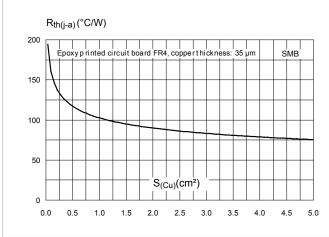


Figure 14. Thermal resistance junction to ambient versus copper surface under each lead (SMB flat)

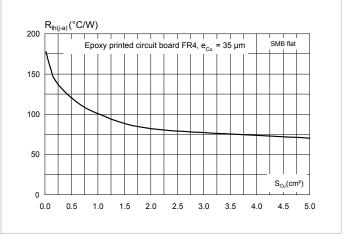
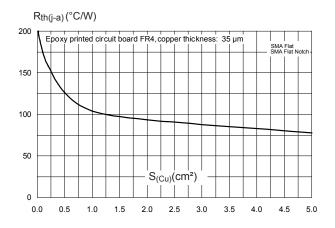


Figure 15. Thermal resistance junction to ambient versus copper surface under each lead (SMA Flat, SMA Flat Notch)





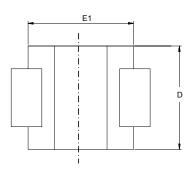
2 Package information

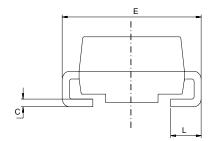
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 SMB package information

- Epoxy meets UL94, V0
- Lead-free package

Figure 16. SMB package outline





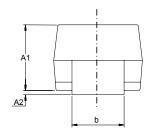
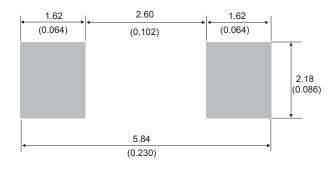


Table 4. SMB package mechanical data

		Dimensions				
Ref.	Millin	neters	Inches (for re	ference only)		
	Min.	Max.	Min.	Max.		
A1	1.90	2.45	0.074	0.097		
A2	0.05	0.20	0.001	0.008		
b	1.95	2.20	0.076	0.087		
С	0.15	0.40	0.005	0.016		
D	3.30	3.95	0.129	0.156		
E	5.10	5.60	0.200	0.221		
E1	4.05	4.60	0.159	0.182		
L	0.75	1.50	0.029	0.060		

Figure 17. SMB recommended footprint



2.2 SMB Flat package information

- Epoxy meets UL94, V0
- Lead-free package

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Figure 18. SMB Flat package outline

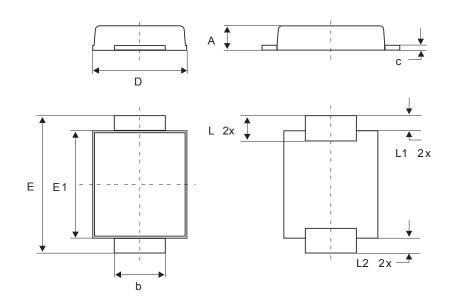


Table 5. SMB Flat mechanical data

			Di	mensions				
Ref.		Millimeters			Inches			
	Min.	Тур.	Max.	Min.	Тур.	Max.		
А	0.90		1.10	0.035		0.044		
b	1.95		2.20	0.076		0.087		
с	0.15		0.40	0.005		0.016		
D	3.30		3.95	0.129		0.156		
Е	5.10		5.60	0.200		0.221		
E1	4.05		4.60	0.159		0.182		
L	0.75		1.50	0.029		0.060		
L1		0.40			0.016			
L2		0.60			0.024			

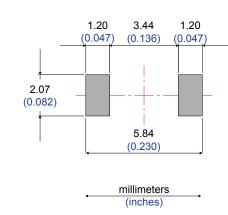


Figure 19. Footprint recommendations, dimensions in mm (inches)

2.3 SMA Flat package information

- Epoxy meets UL94, V0
- Lead-free package

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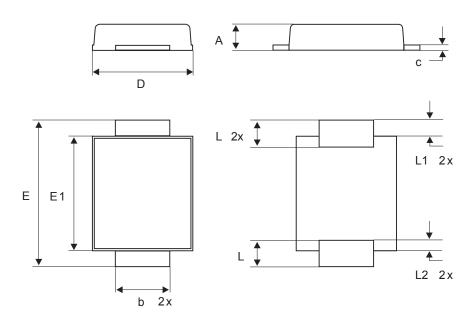
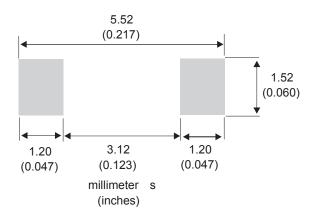


Table 6. SMA Flat package mechanical data

				Dimensions		
Ref.	Millimeters			Inc	ches (for reference on	iy)
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	0.90		1.10	0.035		0.044
b	1.25		1.65	0.049		0.065
С	0.15		0.40	0.005		0.016
D	2.25		2.95	0.088		0.117
E	4.80		5.60	0.188		0.221
E1	3.95		4.60	0.155		0.182
L	0.75		1.50	0.029		0.060
L1		0.50			0.020	
L2		0.50			0.020	







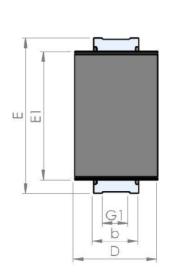
SMA Flat Notch package information 2.4

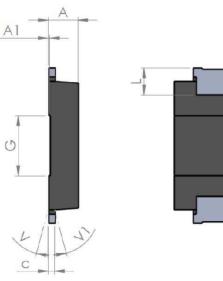
Epoxy meets UL94, V0 •

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- Cooling method: by conduction (C)
- Band indicates cathode

Figure 22. SMA Flat Notch package outline





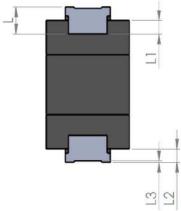
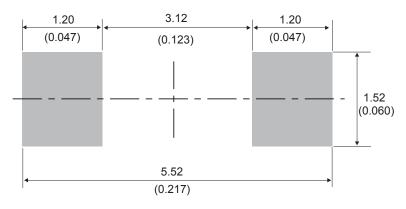


Table 7. SMA Flat Notch package mechanical data

			Dime	nsions		
Ref.		Millimeters		Inches (for reference only)		
	Min.	Тур.	Max.	Min.	Тур.	Max.
A1	0.90		1.10	0.035		0.044
A1		0.05			0.002	
b	1.25		1.65	0.049		0.065
С	0.15		0.40	0.005		0.016
D	2.25		2.90	0.088		0.115
E	5.00		5.35	0.196		0.211
E1	3.95		4.60	0.155		0.182
G		2.00			0.079	
G1		0.85			0.033	
L	0.75		1.20	0.029		
L1		0.45			0.018	
L2		0.45			0.018	
L3		0.05			0.002	
V			8°			8°
V1			8°			8°





3 Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS2L40U	GD4	SMB	0.107 g	2500	Tape and reel
STPS2L40UF	FGD4	SMB Flat	0.050 g	5000	Tape and reel
STPS2L40AF	F2L4	SMA Flat	0.035 g	10 000	Tape and reel
STPS2L40AFN	A24	SMA Flat Notch	0.039 g	10 000	Tape and reel

Table 8. Ordering information

Revision history

Date	Version	Changes
Jul-2003	2A	Last update.
31-Jan-2007	3	Reformatted to current standard. Added ECOPACK statement. Added SMBflat package.
18-Sep-2008	4	Reformatted to current standard. Updated ECOPACK statement. Added SMAflat package.
04-Dec-2018	5	Updated Table 1. Absolute ratings (limiting values at 25 °C, unless otherwise specified) and Figure 5. Normalized avalanche power derating versus pulse duration ($T_j = 125$ °C).
27-Sep-2019	6	Added Section 2.4 SMA Flat Notch package information.

Table 9. Document revision history



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